## SiZ342ADT

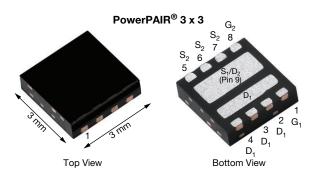
**RoHS** 

COMPLIANT

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**Vishay Siliconix** 

# Dual N-Channel 30 V (D-S) MOSFET



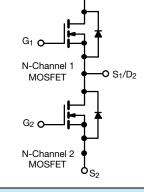
PRODUCT SUMMARY					
MOSFET CHANNEL-1 AND CHANNEL-2					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0094				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0144				
Q <sub>g</sub> typ. (nC)	3.7				
I <sub>D</sub> (A)	33.4 <sup>a</sup>				
Configuration	Dual				

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- High side and low side MOSFETs form optimized combination for 50 % duty cycle
- Optimized  $R_{DS}$   $Q_g$  and  $R_{DS}$   $Q_{gd}$  FOM elevates efficiency for high frequency switching
- 100 %  $R_{\alpha}$  and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Synchronous buck
- DC/DC conversion
- Half bridge
- POL



### **ORDERING INFORMATION**

Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ342ADT-T1-GE3

DADAMETED		CHANNEL-1 AND CHANNEL-2			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	30	V	
Gate-source voltage		V <sub>GS</sub>	+20 / -16		
	T <sub>C</sub> = 25 °C		33.4		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C		26.7	_	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.7 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		12.5 <sup>b, c</sup>		
Pulsed drain current (t = 100 μs)	•	I <sub>DM</sub>	100	— A	
	T <sub>C</sub> = 25 °C		13.9		
Continuous source current (MOSFET diode conduction)	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.1 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	10		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ	
	T <sub>C</sub> = 25 °C		16.7		
NA - The second second second second	T <sub>C</sub> = 70 °C		10.7	<b>—</b> …	
Maximum power dissipation	T <sub>A</sub> = 25 °C	PD	3.7 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		2.4 <sup>b, c</sup>	7	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature)			260		

Notes

- a.  $T_{C} = 25 \ ^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

S19-0945-Rev. A, 11-Nov-2019

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### THERMAL RESISTANCE RATINGS

PABAMETER	AMETED		CHANNEL-1 AND CHANNEL-2			
		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R <sub>thJA</sub>	27	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	6	7.5	0/10	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. Maximum under steady state conditions is 69 °C/W

<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$	, unless othe	rwise noted)					
DADAMETED	CHANNEL-1 AND CHANNEL-2						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	-	2.4	v	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = +20 V / -16 V$	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	5	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 5 \text{ V},  V_{GS} = 10 \text{ V}$	30	-	-	А	
Drain-source on-state resistance <sup>a</sup>	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	- 0.0078 0.009		0.0094	0	
Drain-source on-state resistance "	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	-	0.0120	0.0144	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	57	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	580	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	250	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	$v_{\rm DS} = 15 v, v_{\rm GS} = 0 v, t = 1 w_{\rm HZ}$	-	30	-		
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.052	0.103		
Total gate charge	0	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 15.7 A	-	8.1	12.2		
Total gate charge	Qg		-	3.7	4.5	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 15.7 A	-	2.4	-	no	
Gate-drain charge	Q <sub>gd</sub>		-	0.67	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.24	1.2	2.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.2 \Omega, \text{ I}_{D} \cong 12.5 \text{ A},$	-	6	12		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	18	36		
Fall time	t <sub>f</sub>		-	8	16	20	
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	ns	
Rise time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.2 \Omega, \text{ I}_{D} \cong 12.5 \text{ A},$	-	180	360		
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	20	40		
Fall time	t <sub>f</sub>		-	15	30		



# SiZ342ADT

Vishay Siliconix

<b>SPECIFICATIONS</b> $(1_j = 25^{\circ}C, 0)$	uniess otner	wise holed)					
PARAMETER	CHANNEL-1 AND CHANNEL-2						
FANAMETEN	SYMBOL TEST CONDITIONS			TYP.	MAX.	UNIT	
Drain-source Body Diode Characteristi	cs						
Continuous source-drain diode current	I <sub>S</sub>	$T_{C} = 25^{\circ}C$	-	-	13.9	٨	
Pulse diode forward current	I <sub>SM</sub>		-	-	100	A	
Body diode voltage	V <sub>SD</sub>	$I_{\rm S}$ = 12.5 A, $V_{\rm GS}$ = 0 V	-	0.85	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	15	30	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 12.5 A, di/dt = 100 A/μs,	-	4.3	8.6	nC	
Reverse recovery fall time	ta	T <sub>J</sub> = 25 °C	-	8	-	20	
Reverse recovery rise time	t <sub>b</sub>		-	7	-	ns	

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



T<sub>C</sub> = 125 °C

4.5

6

C

Coss

 $C_{rss}$ 

30

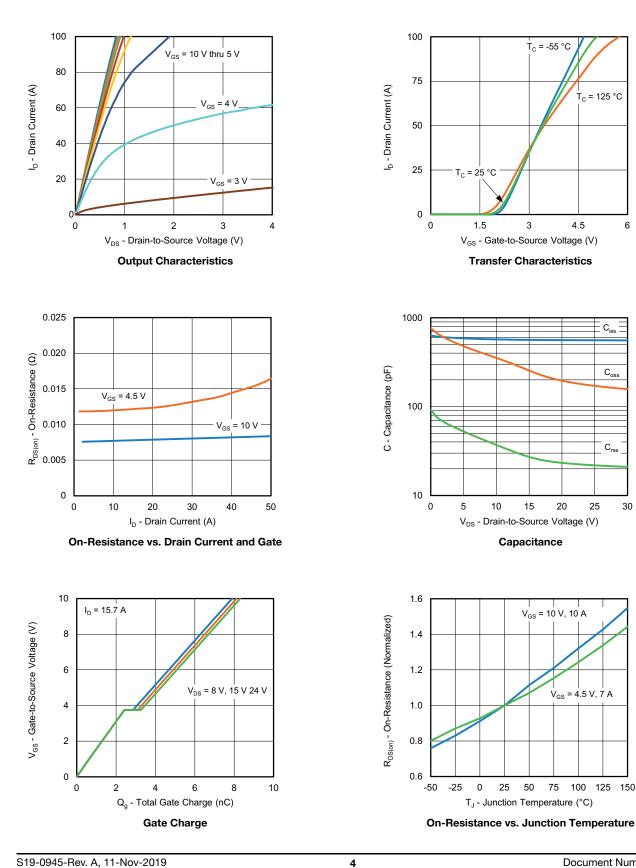
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V<sub>GS</sub> = 4.5 V, 7 A

100

20

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



S19-0945-Rev. A, 11-Nov-2019

For technical questions, contact: pmostechsupport@vishay.com

Document Number: 76711

125 150

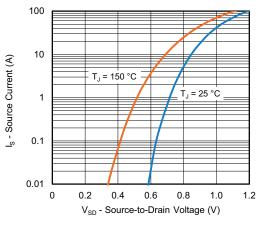
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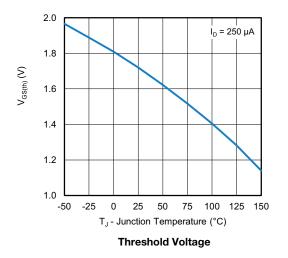
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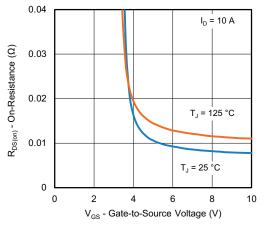
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

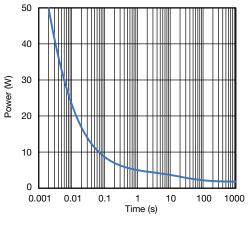


Source-Drain Diode Forward Voltage





**On-Resistance vs. Gate-to-Source Voltage** 

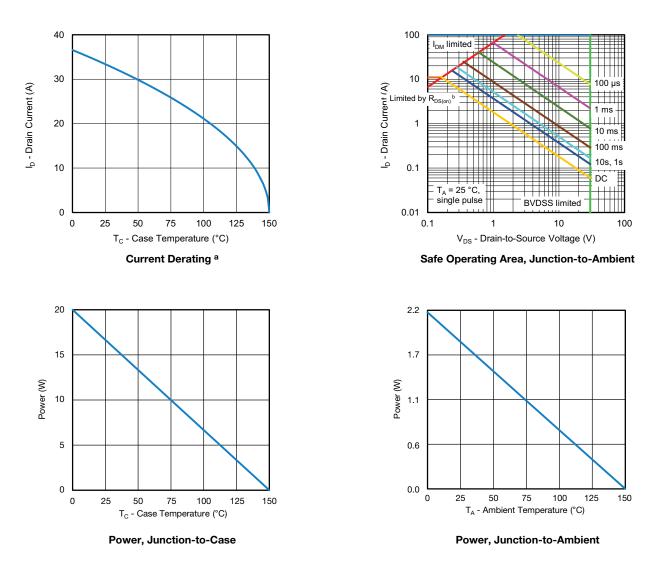


Single Pulse Power

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

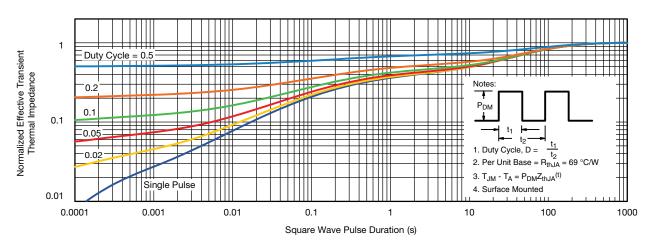


#### Notes

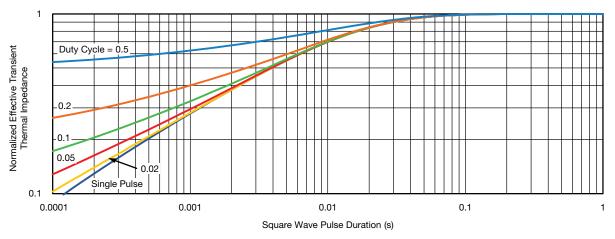
- a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



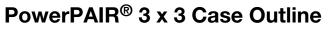
Normalized Thermal Transient Impedance, Junction-to-Ambient

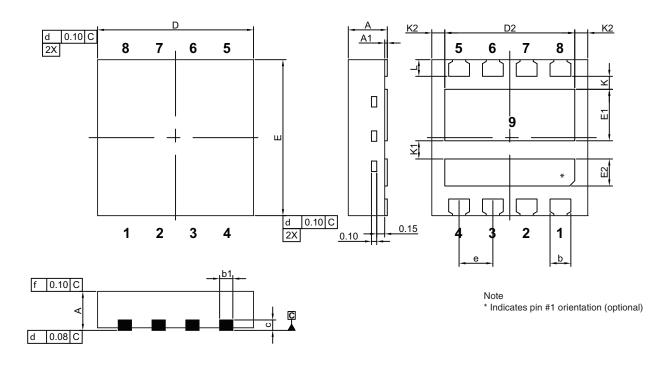


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?76711">www.vishay.com/ppg?76711</a>.







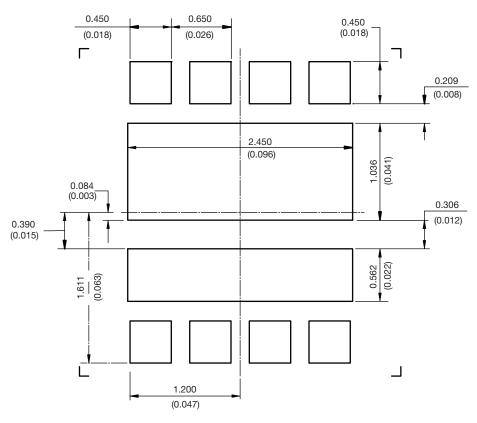
		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00		0.05	0.000		0.002	
b	0.35	0.40	0.45	0.014	0.016	0.018	
b1	0.20	0.25	0.38	0.008	0.010	0.015	
С	0.18	0.20	0.23	0.007	0.008	0.009	
D	2.90	3.00	3.10	0.114	0.118	0.122	
D2	2.35	2.40	2.45	0.093	0.094	0.096	
E	2.90	3.00	3.10	0.114	0.118	0.122	
E1	0.94	0.99	1.04	0.037	0.039	0.041	
E2	0.47	0.52	0.57	0.019	0.020	0.022	
е		0.65 BSC			0.026 BSC		
К		0.25 typ.			0.010 typ.		
K1		0.35 typ.			0.014 typ.		
K2		0.30 typ.			0.012 typ.		
	0.27	0.32	0.37	0.011	0.013	0.015	



PAD Pattern

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#### **RECOMMENDED MINIMUM PAD FOR PowerPAIR® 3 x 3**



Recommended PAD for PowerPAIR 3 x 3 Dimensions in millimeters (inches) Keep-Out 3.5 mm x 3.5 mm for non terminating traces

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